

Vishay Siliconix

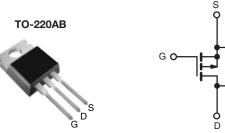
RoHS

COMPLIANT



Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 200				
R _{DS(on)} (Ω)	$V_{GS} = -10 V$	1.5			
Q _g (Max.) (nC)	22				
Q _{gs} (nC)	12				
Q _{gd} (nC)	10				
Configuration	Single				



P-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- P-Channel
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF9620PbF
	SiHF9620-E3
SnPb	IRF9620
	SiHF9620

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unle	ess otherwis	e noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	- 200	- V	
Gate-Source Voltage			V _{GS}	± 20		
Continuous Drain Current	V _{GS} at - 10 V	T _C = 25 °C	- I _D	- 3.5		
		T _C = 100 °C		- 2.0	А	
Pulsed Drain Current ^a			I _{DM}	- 14	1	
Linear Derating Factor			0.32	W/°C		
Maximum Power Dissipation	T _C = 25 °C		PD	40	W	
Peak Diode Recovery dV/dt ^b			dV/dt	lt - 5.0		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	**		
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^c	- °C	
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N·m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $I_{SD} \leq$ - 3.5 A, dl/dt \leq 95 A/µs, $V_{DD} \leq V_{DS},\,T_J \leq$ 150 °C.

c. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP. MAX.			UNIT			
Maximum Junction-to-Ambient	R _{thJA}	- 62 0.50 - - 3.1			°C/W			
Case-to-Sink, Flat, Greased Surface	R _{thCS}							
Maximum Junction-to-Case (Drain)	R _{thJC}							
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	Inless otherw	rise noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static	•							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	0 V, I _D = - 2	250 µA	- 200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I	_D = - 1 mA	-	- 0.22	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = -	250 µA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}	1	$I_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Zaura Orata Malta na Duain Orumant		V _{DS} =	- 200 V, V _G	_{iS} = 0 V	-	-	- 100	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = - 160 \	V_{DS} = - 160 V, V_{GS} = 0 V, T_{J} = 125 °C		-	-	- 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D :	= - 1.5 A ^b	-	-	1.5	Ω
Forward Transconductance	g _{fs}	V _{DS} = -	50 V, I _D =	- 1.5 A ^b	1.0	-	-	S
Dynamic	•					•	•	
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$ $V_{DS} = -25 V,$		-	350	-	pF
Output Capacitance	C _{oss}	١			-	100	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see		e fig. 5	-	30	-	
Total Gate Charge	Qg			-	-	22	nC	
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V	$V_{GS} = -10 V$ $I_D = -4.0$ see fig		-	-		12
Gate-Drain Charge	Q _{gd}			j. Trana to	-	-		10
Turn-On Delay Time	t _{d(on)}		V_{DD} = - 100 V, I _D = - 1.5 A, R _g = 50 Ω, R _D = 67 Ω, see fig. 17 ^b		-	15	-	ns
Rise Time	t _r	V _{DD} = -			-	25	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 50 \Omega$,			-	20	-	
Fall Time	t _f				-	15	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-		
Internal Source Inductance	L _S			-	7.5	-	nH	
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 3.5	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	- 14		
Body Diode Voltage	V _{SD}	$T_{J} = 25 \ ^{\circ}\text{C}, \ I_{S} = - \ 3.5 \ \text{A}, \ V_{GS} = 0 \ V^{b}$			-	-	- 7.0	V
Body Diode Reverse Recovery Time	t _{rr}	− T _J = 25 °C, I _F = - 3.5 A, dl/dt = 100 A/μs ^b		-	300	450	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	1.9	2.9	μC	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

t_{on}

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 %.

Forward Turn-On Time

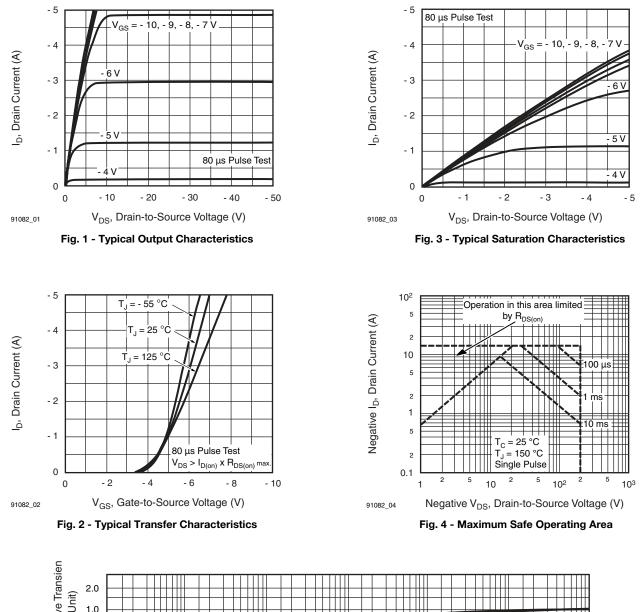
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Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 $Z_{th,JC}(t)/R_{th,JC},$ Normalized Effective Transien Thermal Impedence (Per Unit) 1.0 0.5 0.5 D P_{DM} 0 2 0.2 0. ŢΠ 0.1 <t₁→ 0.05 0.05 -Notes: Single Pulse (Transient 0.01 1. Duty Factor, $D = t_1/t_2$ Thermal Impedence) 0.02 -2. Per Unit Base = R_{thJC} = 3.12 °C/W -3. T_{JM} $-T_{C} = P_{DM} Z_{thJC}(t)$ 0.01 2 2 2 5 2 5 5 10⁻² 5 2 5 2 5 10-4 10⁻³ 0.1 1.0 10 10-5 91082_05 t₁, Square Wave Pulse Duration (s) Fig. 5 - Maximum Effective Transient Thermal Impedance, Junction-to-Case vs. Pulse Duration

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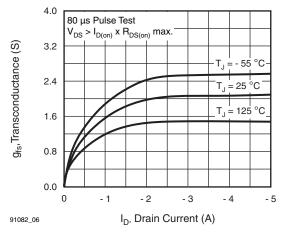


Fig. 6 - Typical Transconductance vs. Drain Current

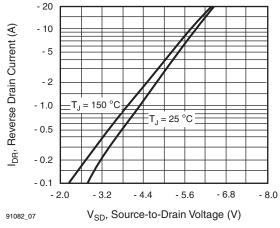
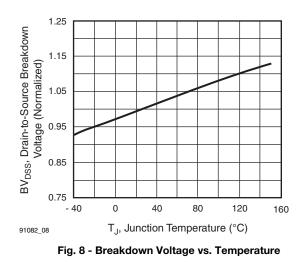


Fig. 7 - Typical Source-Drain Diode Forward Voltage



R_{DS(on)}, Drain-to-Source On Resistance 2.5 I_D = - 1.0 A 10 V = -GS 2.0 (Normalized) 1.5 1.0 0.5 0.0 0 40 - 40 80 120 160 T_J, Junction Temperature (°C) 91082_09

Fig. 9 - Normalized On-Resistance vs. Temperature

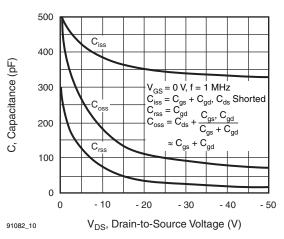
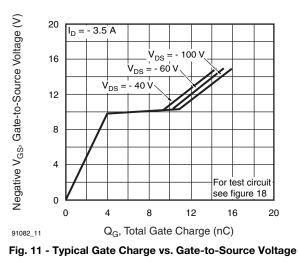


Fig. 10 - Typical Capacitance vs. Drain-to-Source Voltage



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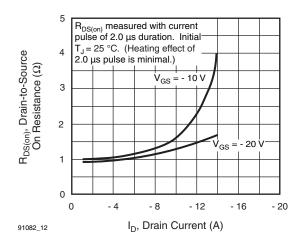


Fig. 12 - Typical On-Resistance vs. Drain Current

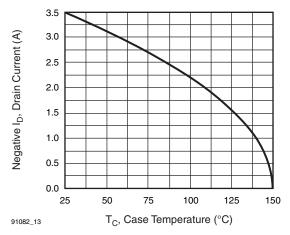
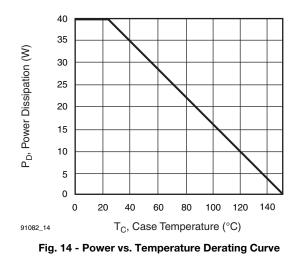


Fig. 13 - Maximum Drain Current vs. Case Temperature



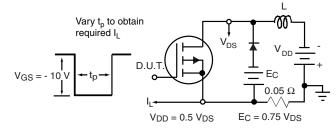


Fig. 15 - Clamped Inductive Test Circuit

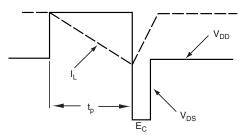


Fig. 16 - Clamped Inductive Waveforms

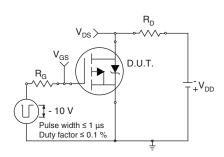


Fig. 17a - Switching Time Test Circuit

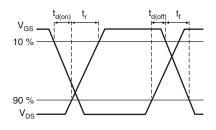
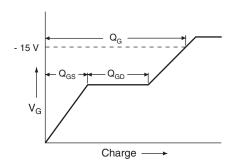


Fig. 17b - Switching Time Waveforms

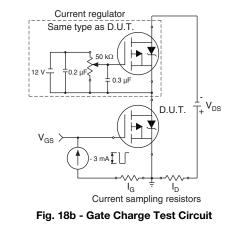
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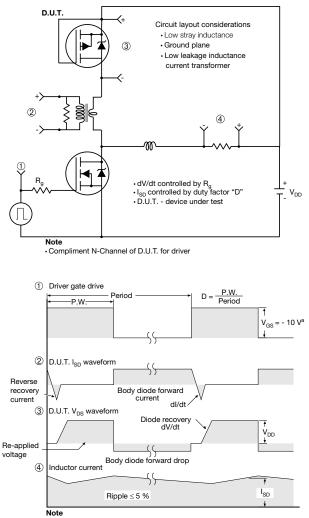












- 5 V for logic level and - 3 V drive devices a. V_{GS} =

Fig. 19 - For P-Channel

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